

MOSFET

OptiMOS[™] 5 Power-Transistor, 80 V

Features

- Optimized for high performance SMPS, e.g. synchronous rectification
 100% avalanche tested
 Superior thermal resistance

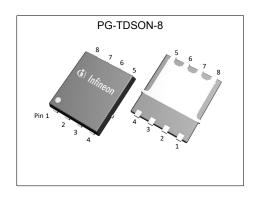
- N-channel, logic level
- Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

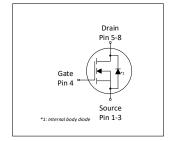
Product validation

Qualified according to JEDEC Standard

Table 1 **Key Performance Parameters**

| rable i Rey i crioimance i arameters | | | | | | | | |
|---|-------|------|--|--|--|--|--|--|
| Parameter | Value | Unit | | | | | | |
| $V_{	extsf{DS}}$ | 80 | V | | | | | | |
| R _{DS(on),max} , V _{GS} = 10V | 2.3 | mΩ | | | | | | |
| $R_{DS(on),max}$, V_{GS} = 4.5V | 3.0 | mΩ | | | | | | |
| I D | 195 | A | | | | | | |
| Qoss | 88 | nC | | | | | | |
| Q _G (0V4.5V) | 44 | nC | | | | | | |











| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|---------|---------------|
| ISC0605NLS | PG-TDSON-8 | 0605NLS | - |

OptiMOS[™] 5 Power-Transistor, 80 V ISC0605NLS



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OptiMOS[™] 5 Power-Transistor, 80 V ISC0605NLS



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

| Damamatan | Oh al | Values | | | | |
|--|-----------------------------------|-------------|-------------|-------------------------|------|---|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | - - - | - - - | 195 123 108 25 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm C}$ =100 °C ²⁾ $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50°C/W ³⁾ |
| Pulsed drain current ²⁾ | I _{D,pulse} | - | - | 778 | Α | <i>T</i> _A =25 °C |
| Avalanche energy, single pulse ⁴⁾ | E _{AS} | - | - | 370 | mJ | $I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω |
| Gate source voltage | V _{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 156 2.5 | W | T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ³⁾ |
| Operating and storage temperature | T _j , T _{stg} | -55 | - | 150 | °C | - |

2 Thermal characteristics

Table 3 Thermal characteristics

| Baramatar | Symbol | Values | | | llnit | Note / Test Condition |
|--|-------------------|--------|------|------|-------|-----------------------|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Thermal resistance, junction - case | R _{thJC} | - | 0.5 | 0.8 | °C/W | - |
| Device on PCB, 6 cm² cooling area ³⁾ | R _{thJA} | - | - | 50 | °C/W | - |

²⁾ See Diagram 3 for more detailed information

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

³⁾ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

4) See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 80 V ISC0605NLS



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

| D | 0 | | Values | | | | |
|----------------------------------|----------------------|------|--------------|------------|------|---|--|
| Parameter | Symbol | Min. | Min. Typ. Ma | | Unit | Note / Test Condition | |
| Drain-source breakdown voltage | V _{(BR)DSS} | 80 | - | - | V | V _{GS} =0 V, I _D =1 mA | |
| Gate threshold voltage | V _{GS(th)} | 1.1 | 1.7 | 2.3 | V | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 115 \mu {\rm A}$ | |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μΑ | V _{DS} =80 V, V _{GS} =0 V, T _j =25 °C V _{DS} =80 V, V _{GS} =0 V, T _j =125 °C | |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V | |
| Drain-source on-state resistance | R _{DS(on)} | - | 2.1 2.6 | 2.3 3.0 | mΩ | V _{GS} =10 V, I _D =50 A V _{GS} =4.5 V, I _D =25 A | |
| Gate resistance ¹⁾ | R _G | - | 1.7 | 2.6 | Ω | - | |
| Transconductance | g fs | 70 | 140 | - | S | $ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 50 A$ | |

Table 5 Dynamic characteristics

| Parameter | Ol | Values | | | 11 | Note (Total Constitution |
|--|------------------|--------|------|------|------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Input capacitance ¹⁾ | C _{iss} | - | 5800 | 7500 | pF | V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz |
| Output capacitance ¹⁾ | Coss | - | 840 | 1100 | pF | V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz |
| Reverse transfer capacitance ¹⁾ | C _{rss} | - | 34 | 60 | pF | V _{GS} =0 V, V _{DS} =40 V, <i>f</i> =1 MHz |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 10.4 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |
| Rise time | t _r | - | 10.3 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |
| Turn-off delay time | $t_{ m d(off)}$ | - | 51 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |
| Fall time | t _f | - | 18.6 | - | ns | $V_{\rm DD}$ =40 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =3 Ω |

Table 6 Gate charge characteristics²⁾

| Parameter | O. mak al | | Values | | 11 | |
|------------------------------------|----------------------|------|--------|------|------|---|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 16 | - | nC | $V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Gate charge at threshold | $Q_{g(th)}$ | - | 10 | - | nC | $V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Gate to drain charge ¹⁾ | $Q_{ m gd}$ | - | 15 | 22 | nC | $V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Switching charge | Q _{sw} | - | 21 | - | nC | $V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Gate charge total ¹⁾ | Qg | - | 44 | 55 | nC | $V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Gate plateau voltage | V _{plateau} | - | 2.8 | - | V | $V_{\rm DD}$ =40 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 4.5 V |
| Gate charge total, sync. FET | Q _{g(sync)} | - | 36 | - | nC | V _{DS} =0.1 V, V _{GS} =0 to 4.5 V |
| Output charge ¹⁾ | Q _{oss} | - | 88 | 117 | nC | V _{DS} =40 V, V _{GS} =0 V |

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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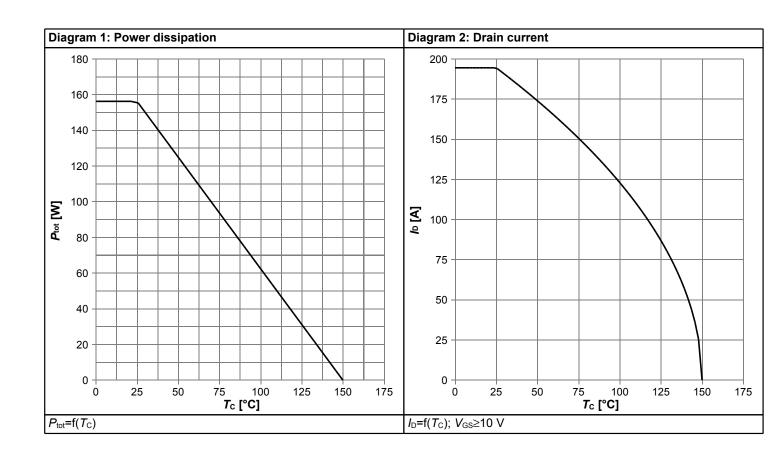


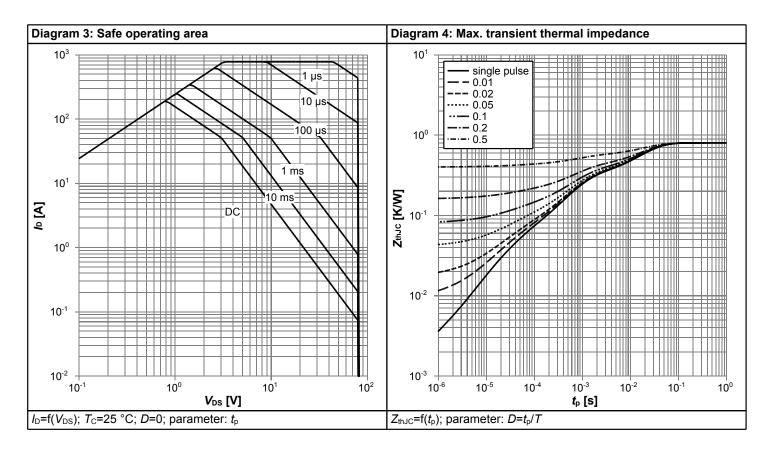
Table 7 Reverse diode

| Dougnation . | Cumbal | | Values | S | I I to i4 | Note / Test Condition | |
|---------------------------------------|----------------------|------|--------|------|-----------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | | |
| Diode continuous forward current | Is | - | - | 110 | Α | <i>T</i> _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 778 | Α | <i>T</i> _C =25 °C | |
| Diode forward voltage | V _{SD} | - | 0.85 | 1.2 | V | V _{GS} =0 V, I _F =50 A, T _j =25 °C | |
| Reverse recovery time ¹⁾ | t _{rr} | - | 44 | 87 | ns | V _R =40 V, I _F =50 A, di _F /dt=100 A/μs | |
| Reverse recovery charge ¹⁾ | Qrr | - | 47 | 93 | nC | V_R =40 V, I_F =50 A, di_F/dt =100 A/ μ s | |

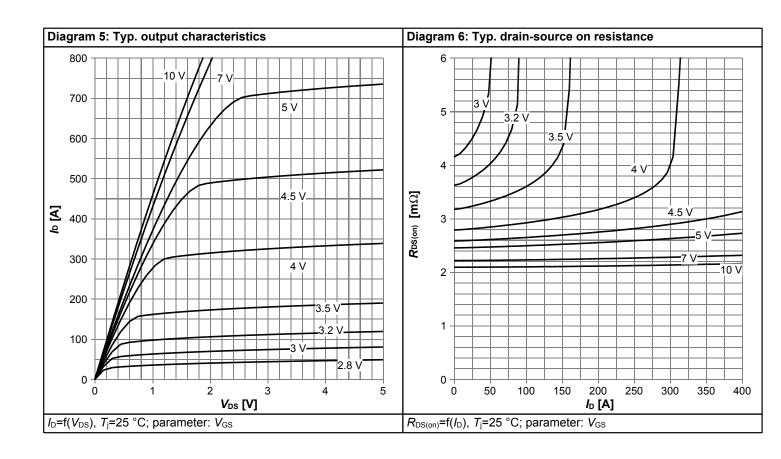


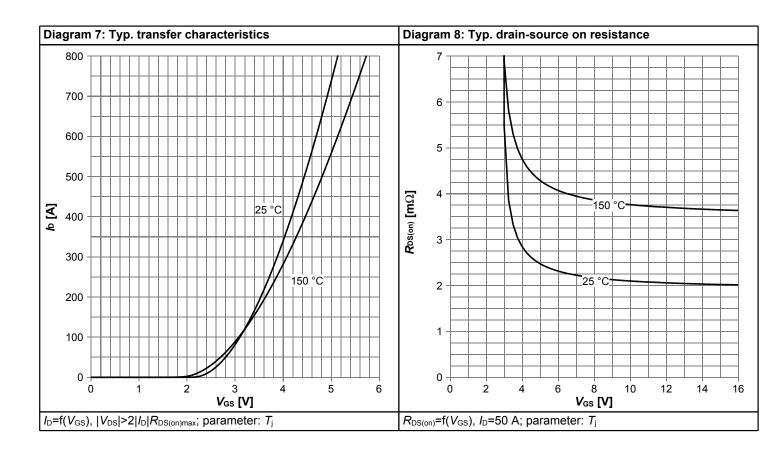
4 Electrical characteristics diagrams



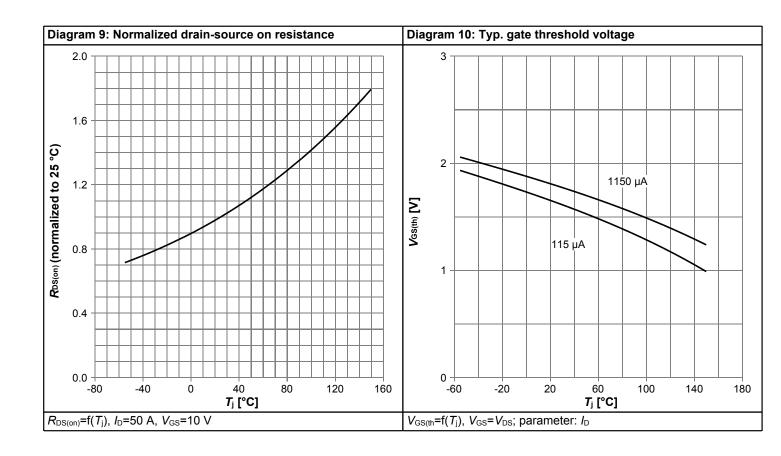


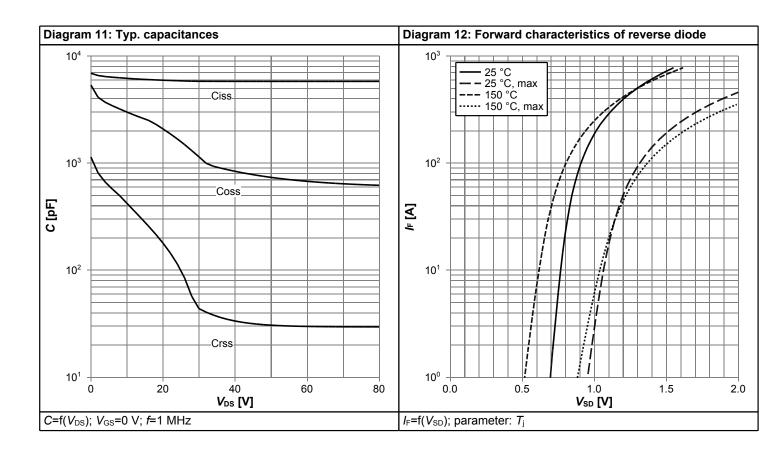




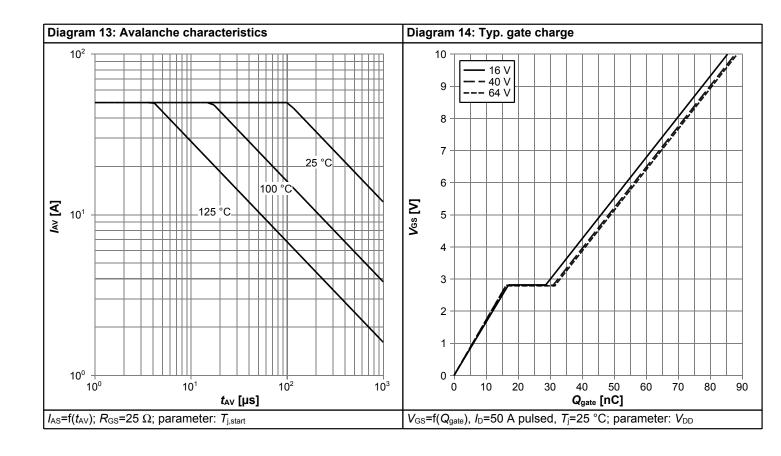


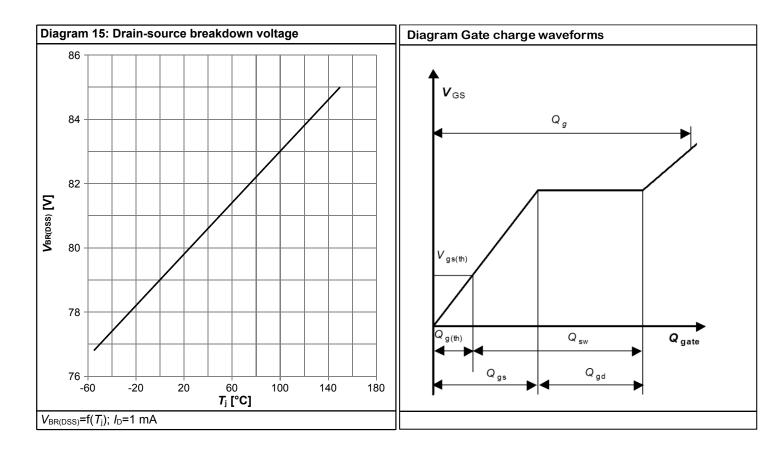






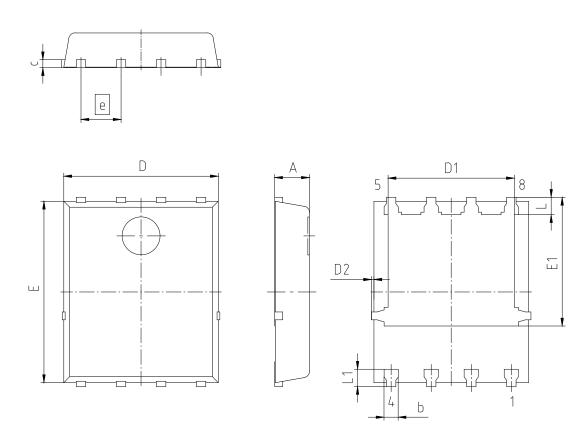








5 Package Outlines



| PACKAGE - GROUP NUMBER: | PG-TDS | PG-TDSON-8-U08 | | | | | |
|----------------------------|-------------|----------------|--|--|--|--|--|
| DIMENSIONS | MILLIMETERS | | | | | | |
| DIMENSIONS | MIN. | MAX. | | | | | |
| Α | 0.90 | 1.20 | | | | | |
| b | 0.34 | 0.54 | | | | | |
| С | 0.15 | 0.35 | | | | | |
| D | 4.80 | 5.35 | | | | | |
| D1 | 3.90 | 4.40 | | | | | |
| D2 | 0.00 | 0.22 | | | | | |
| E | 5.70 | 6.10 | | | | | |
| E1 | 4.05 | 4.25 | | | | | |
| е | 1.27 | | | | | | |
| L | 0.45 | 0.65 | | | | | |
| L1 | 0.45 | 0.65 | | | | | |

- 1) EXCLUDING MOLD FLASH
- 2) REMOVAL ON MOLD GATE INTRUSION 0.1 MM PROTRUSION 0.1 MM
- 3) ALL METAL SURFACES ARE PLATED, EXCEPT AREA OF CUT

Figure 1 Outline PG-TDSON-8, dimensions in mm

OptiMOS[™] 5 Power-Transistor, 80 V





Revision History

ISC0605NLS

Revision: 2023-01-13, Rev. 2.1

| Previous Revision | 'n |
|-------------------|----|

| 1 Torrodo Terrolott | | | | | | |
|---------------------|------------|--|--|--|--|--|
| Revision | Date | Subjects (major changes since last revision) | | | | |
| 2.0 | 2022-07-14 | Release of final version | | | | |
| 2.1 | 2023-01-13 | Updated Features and Table1_Key Performance Parameters | | | | |

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